

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT								
NATURE OF CONVEYANCE:	ASSIGNMENT								
CONVEYING PARTY DATA									
<table border="1"> <thead> <tr> <th>Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>JEN-CHUN CHEN</td> <td>01/21/2013</td> </tr> <tr> <td>PAI-SHENG SHIH</td> <td>01/21/2013</td> </tr> <tr> <td>HSIN CHIN CHANG</td> <td>01/21/2013</td> </tr> </tbody> </table>		Name	Execution Date	JEN-CHUN CHEN	01/21/2013	PAI-SHENG SHIH	01/21/2013	HSIN CHIN CHANG	01/21/2013
Name	Execution Date								
JEN-CHUN CHEN	01/21/2013								
PAI-SHENG SHIH	01/21/2013								
HSIN CHIN CHANG	01/21/2013								
RECEIVING PARTY DATA									
Name:	UNIVERSAL SCIENTIFIC INDUSTRIAL (SHANGHAI) CO., LTD.								
Street Address:	NO. 1558, ZHANG DONG ROAD, ZHANGJIANG HI-TECH PARK								
City:	SHANGHAI								
State/Country:	CHINA								
Postal Code:	201203								
Name:	UNIVERSAL GLOBAL SCIENTIFIC INDUSTRIAL CO., LTD.								
Street Address:	NO.141, LN. 351, SEC. 1, TAIPING RD., CAOTUN TOWNSHIP								
City:	NANTOU COUNTY								
State/Country:	TAIWAN								
Postal Code:	54261								
PROPERTY NUMBERS Total: 1									
<table border="1"> <thead> <tr> <th>Property Type</th> <th>Number</th> </tr> </thead> <tbody> <tr> <td>Application Number:</td> <td>13747979</td> </tr> </tbody> </table>		Property Type	Number	Application Number:	13747979				
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CORRESPONDENCE DATA									
Fax Number:	7035745876								
<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>									
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CH \$40.00 13747979

ATTORNEY DOCKET NUMBER:	101P000954US
NAME OF SUBMITTER:	ZHUO XU
Total Attachments: 2 source=20954Assignment#page1.tif source=20954Assignment#page2.tif	

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UNITED STATES PATENT RIGHTS, OR
 UNITED STATES PLUS ALL FOREIGN PATENT RIGHTS

ASSIGNMENT

Application No. _____ Filed _____

*** (Given Name FAMILY NAME (ALL CAPS)) ***

Insert Name(s) of Inventor(s) ⇒ WHEREAS, (1) CHEN, JENCHUN (FAMILY NAME: CHEN)
 (2) SHIH, PAI-SHENG (FAMILY NAME: SHIH)
 (3) CHANG, HSIN CHIN (FAMILY NAME: CHANG)
 (hereinafter designated as the undersigned) has (have) invented certain new and useful improvements in:

Insert Title of Invention ⇒ ELECTRONIC MODULE AND METHOD FOR SAME
 for which an application for Letters Patent of the United States of America has been executed by the undersigned (except in the case of a provisional application)

Insert Date of Signing of Appln. ⇒ On _____; and

Insert Name of Assignee ⇒ WHEREAS, (1) UNIVERSAL SCIENTIFIC INDUSTRIAL (SHANGHAI) CO., LTD.
 (2) UNIVERSAL GLOBAL SCIENTIFIC INDUSTRIAL CO., LTD.
 Insert Address of Assignee ⇒ of (1) NO. 1558, ZHANG DONG ROAD, ZHANGJIANG HI-TECH PARK, SHANGHAI, P.R.CHINA 201203
 (2) NO.141, LN. 351, SEC. 1, TAIPING RD., CAOTUN TOWNSHIP, NANTOU COUNTY 54261, TAIWAN, R.O.C.
 its heirs, successors, legal representatives and assigns (hereinafter designated as the Assignee) is desirous of acquiring the entire right, title and interest in and to said invention and in and to any Letters Patent(s) that may be granted therefor in the United States of America and

Check Box if Appropriate ⇒ in any foreign countries.

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, the undersigned has (have) sold, assigned and transferred, and by these presents does sell, assign and transfer unto said Assignee the full and exclusive right to the said invention in the United States of America, its territories, dependencies and possessions and the entire right, title and interest in and to any and all Letters Patent(s) which may be granted therefor in the United States of America, its territories, dependencies and possessions, and if the box above is designated, in any and all foreign countries; and to any and all divisions, reissues, continuations, conversions and extensions thereof for the full term or terms for which the same may be granted.

The undersigned agree(s) to execute all papers necessary in connection with this application and any continuing, divisional, conversion or reissue applications thereof and also to execute separate assignments in connection with such applications as the Assignee may deem necessary or expedient.

The undersigned agree(s) to execute all papers necessary in connection with any interference which may be declared concerning this application or continuation, division, conversion or reissue thereof or Letters Patent(s) or reissue patent issued thereon and to cooperate with the Assignee in every way possible in obtaining and producing evidence and proceeding with such interference.

The undersigned agree(s) to execute all papers and documents and to perform any act which may be necessary in connection with claims or provisions of the International Convention for the Protection of Industrial Property or similar agreements.

The undersigned agree(s) to perform all affirmative acts which may be necessary to obtain a grant of a valid United States of America patent(s) or a grant of a valid United States of America and any foreign patent(s) to the Assignee and to vest all rights therein hereby conveyed to said Assignee as fully and entirely as the same would have been held by the undersigned if this Assignment and sale had not been made.

The undersigned hereby authorize(s) and request(s) the Patent and Trademark Office Officials in the United States of America and in any foreign countries to issue any and all Letters Patent(s) resulting from said application or any continuing, divisional conversion or reissue applications thereof to the said Assignee, as Assignee of the entire interest, and hereby covenants that he has (they have) the full right to convey the entire interest herein assigned, and that he has (they have) not executed, and will not execute, any agreement in conflict herewith.

The undersigned hereby grant(s) the law firm of LI&CAI INTELLECTUAL PROPERTY (USA) OFFICE the power to insert on this Assignment any further identification which may be necessary or desirable in order to comply with the rules of the U.S. Patent and Trademark Office for recordation of this document.

The undersigned hereby covenant(s) that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this Assignment.

In witness whereof, executed by the undersigned on the date(s) opposite the undersigned name(s).

Date JAN. 21, 2013 Name of Inventor CHEN, JENCHUN (FAMILY NAME: CHEN)
(Signature) *Chen Jen Chun*

Date JAN. 21, 2013 Name of Inventor SHIH, PAI-SHENG (FAMILY NAME: SHIH)
(Signature) *Shih - Pai Sheng*

Date JAN. 21, 2013 Name of Inventor CHANG, HSIN CHIN (FAMILY NAME: CHANG)
(Signature) *Chang Hsin Chin*

Date _____ Name of Inventor _____
(Signature)

Date _____ Name of Inventor _____
(Signature)

Date _____ Name of Inventor _____
(Signature)